



# CMOS Low Cost 10-Bit Multiplying DAC

## AD7533

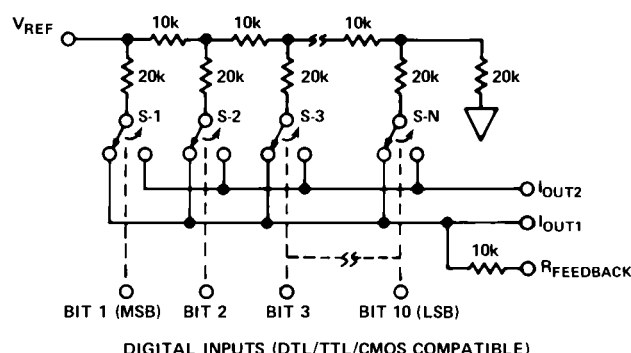
### FEATURES

Lowest Cost 10-Bit DAC  
Low Cost AD7520 Replacement  
Linearity: 1/2, 1 or 2LSB  
Low Power Dissipation  
Full Four-Quadrant Multiplying DAC  
CMOS/TTL Direct Interface  
Latch Free (Protection Schottky not Required)  
End-Point Linearity

### APPLICATIONS

Digitally Controlled Attenuators  
Programmable Gain Amplifiers  
Function Generation  
Linear Automatic Gain Control

Functional Block Diagram



Logic: A switch is closed to  $I_{OUT1}$  for its digital input in a "HIGH" state.

### GENERAL DESCRIPTION

The AD7533 is a low cost 10-bit 4-quadrant multiplying DAC manufactured using an advanced thin-film-on-monolithic-CMOS wafer fabrication process.

Pin and function equivalent to the industry standard AD7520, the AD7533 is recommended as a lower cost alternative for old AD7520 sockets or new 10-bit DAC designs.

AD7533 application flexibility is demonstrated by its ability to interface to TTL or CMOS, operate on +5V to +15V power, and provide proper binary scaling for reference inputs of either positive or negative polarity.

### ORDERING GUIDE<sup>1</sup>

Model <sup>2</sup>	Temperature Range	Nonlinearity (%FSR max)	Package Option <sup>3</sup>
AD7533JN	-40°C to +85°C	±0.2	N-16
AD7533KN	-40°C to +85°C	±0.1	N-16
AD7533LN	-40°C to +85°C	±0.05	N-16
AD7533JP	-40°C to +85°C	±0.2	P-20A
AD7533KP	-40°C to +85°C	±0.1	P-20A
AD7533LP	-40°C to +85°C	±0.05	P-20A
AD7533JR	-40°C to +85°C	±0.2	R-16
AD7533KR	-40°C to +85°C	±0.1	R-16
AD7533LR	-40°C to +85°C	±0.05	R-16
AD7533AQ	-40°C to +85°C	±0.2	Q-16
AD7533BQ	-40°C to +85°C	±0.1	Q-16
AD7533CQ	-40°C to +85°C	±0.05	Q-16
AD7533SQ	-55°C to +125°C	±0.2	Q-16
AD7533TQ	-55°C to +125°C	±0.1	Q-16
AD7533UQ	-55°C to +125°C	±0.05	Q-16
AD7533SE	-55°C to +125°C	±0.2	E-20A
AD7533TE	-55°C to +125°C	±0.1	E-20A
AD7533UE	-55°C to +125°C	±0.05	E-20A

### NOTES

<sup>1</sup>Analog Devices reserves the right to ship ceramic (package outline D-16) packages in lieu of cerdip (package outline Q-16) packages.

<sup>2</sup>To order MIL-STD-883, Class B processed parts, add /883B to part number. Contact your local sales office for military data sheet.

<sup>3</sup>E = Leadless Ceramic Chip Carrier; N = Plastic DIP; P = Plastic Leaded Chip Carrier; Q = Cerdip; R = SOIC.

REV. A

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# AD7533—SPECIFICATIONS ( $V_{DD} = +15V$ , $V_{OUT1} = V_{OUT2} = 0V$ ; $V_{REF} = +10V$ unless otherwise noted)

PARAMETER	$T_A = 25^\circ C$	$T_A = \text{Operating Range}$	Test Conditions
<b>STATIC ACCURACY</b>			
Resolution	10 Bits	10 Bits	
Relative Accuracy <sup>1</sup>			
AD7533JN, AD, SD, AQ, SQ	$\pm 0.2\%$ FSR max	$\pm 0.2\%$ FSR max	Digital Inputs = $V_{INH}$
AD7533KN, BD, TD, BQ, TQ	$\pm 0.1\%$ FSR max	$\pm 0.1\%$ FSR max	
AD7533LN, CD, UD, CQ, UQ	$\pm 0.05\%$ FSR max	$\pm 0.05\%$ FSR max	
Gain Error <sup>2,3</sup>	$\pm 1.4\%$ FS max	$\pm 1.5\%$ FS max	
Supply Rejection <sup>4</sup>			Digital Inputs = $V_{INH}$ ; $V_{DD} = +14V$ to $+17V$
$\Delta\text{Gain}/\Delta V_{DD}$	0.005%/%	0.008%/%	
Output Leakage Current			Digital Inputs = $V_{INL}$ ; $V_{REF} = \pm 10V$
$I_{OUT1}$	$\pm 50nA$ max	$\pm 200nA$ max	Digital Inputs = $V_{INH}$ ; $V_{REF} = \pm 10V$
$I_{OUT2}$	$\pm 50nA$ max	$\pm 200nA$ max	
<b>DYNAMIC ACCURACY</b>			
Output Current Settling Time	600ns max <sup>4</sup>	800ns <sup>5</sup>	To 0.05% FSR; $R_{LOAD} = 100\Omega$ ; Digital Inputs = $V_{INH}$ to $V_{INL}$ or $V_{INL}$ to $V_{INH}$
Feedthrough Error	$\pm 0.05\%$ FSR max <sup>5</sup>	$\pm 0.1\%$ FSR max <sup>5</sup>	Digital Inputs = $V_{INL}$ ; $V_{REF} = \pm 10V$ , 100kHz sine wave.
<b>REFERENCE INPUT</b>			
Input Resistance (Pin 15)	5k $\Omega$ min, 20k $\Omega$ max	5k $\Omega$ min, 20k $\Omega$ max <sup>6</sup>	
<b>ANALOG OUTPUTS</b>			
Output Capacitance			
$C_{OUT1}$	100pF max <sup>5</sup>	100pF max <sup>5</sup>	Digital Inputs = $V_{INH}$
$C_{OUT2}$	35pF max <sup>5</sup>	35pF max <sup>5</sup>	
$C_{OUT1}$	35pF max <sup>5</sup>	35pF max <sup>5</sup>	Digital Inputs = $V_{INL}$
$C_{OUT2}$	100pF max <sup>5</sup>	100pF max <sup>5</sup>	
<b>DIGITAL INPUTS</b>			
Input High Voltage			
$V_{INH}$	2.4V min	2.4V min	
Input Low Voltage			
$V_{INL}$	0.8V max	0.8V max	
Input Leakage Current			$V_{IN} = 0V$ and $V_{DD}$
$I_{IN}$	$\pm 1\mu A$ max	$\pm 1\mu A$ max	
Input Capacitance			
$C_{IN}$	8pF max <sup>5</sup>	8pF max <sup>5</sup>	
<b>POWER REQUIREMENTS</b>			
$V_{DD}$	$+15V \pm 10\%$	$+15V \pm 10\%$	Rated Accuracy
$V_{DD}$ Range <sup>5</sup>	$+5V$ to $+16V$	$+5V$ to $+16V$	Functionality with Degraded Performance
$I_{DD}$	2mA max	2mA max	Digital Inputs = $V_{INL}$ or $V_{INH}$

## NOTES

<sup>1</sup>"FSR" is Full-Scale Range.

<sup>2</sup>Full Scale (FS) =  $(V_{REF})$

<sup>3</sup>Max gain change from  $T_A = +25^\circ C$  to  $T_{min}$  or  $T_{max}$  is  $\pm 0.1\%$  FSR.

<sup>4</sup>AC parameter, sample tested to ensure specification compliance.

<sup>5</sup>Guaranteed, not tested.

<sup>6</sup>Absolute temperature coefficient is approximately  $-300ppm/^\circ C$ .

Specifications subject to change without notice.

**ABSOLUTE MAXIMUM RATINGS\***(T<sub>A</sub> = +25°C unless otherwise noted)

V <sub>DD</sub> to GND	−0.3V, +17V
R <sub>FB</sub> to GND	±25V
V <sub>REF</sub> to GND	±25V
Digital Input Voltage Range	−0.3V to V <sub>DD</sub> + 0.3V
OUT 1, OUT 2 to GND	−0.3V to V <sub>DD</sub>
Power Dissipation (Any Package)	
To +75°C	450mW
Derates above +75°C by	6mW/°C
Operating Temperature Range	
Plastic (JN, KN, LN versions)	0 to +70°C

Hermetic (AD, BD, CD, AQ, BQ, CQ versions)	−25°C to +85°C
Hermetic (SD, TD, UD, SQ, TQ, UQ versions)	−55°C to +125°C
Storage Temperature	−65°C to +150°C
Lead Temperature (Soldering, 10sec)	+300°C

\*Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**CAUTION:**

ESD (Electro-Static-Discharge) sensitive device. The digital control inputs are diode protected; however, permanent damage may occur on unconnected devices subjected to high energy electrostatic fields. Unused devices must be stored in conductive foam or shunts. The foam should be discharged to the destination socket before devices are removed.

**TERMINOLOGY**

**RELATIVE ACCURACY:** Relative accuracy or end-point nonlinearity is a measure of the maximum deviation from a straight line passing through the endpoints of the DAC transfer function. It is measured after adjusting for ideal zero and full scale and is expressed in % of full-scale range or (sub) multiples of 1LSB.

**RESOLUTION:** Value of the LSB. For example, a unipolar converter with n bits has a resolution of  $(2^{-n}) (V_{REF})$ . A bipolar converter of n bits has a resolution of  $[2^{-(n-1)}] (V_{REF})$ . Resolution in no way implies linearity.

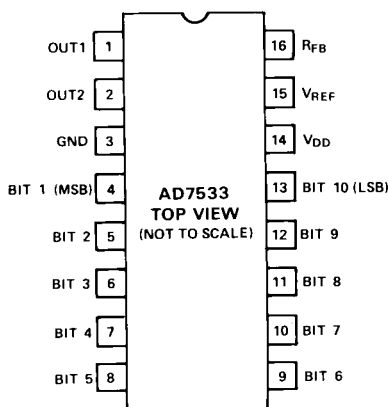
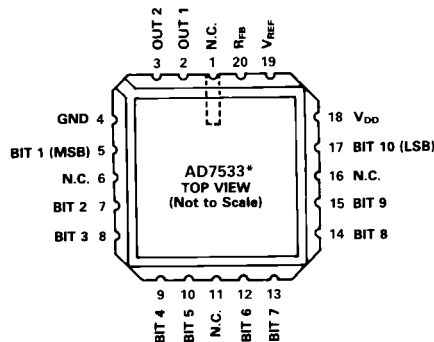
**SETTLING TIME:** Time required for the output function of the DAC to settle to within 1/2LSB for a given digital input stimulus, i.e., 0 to Full Scale.

**GAIN ERROR:** Gain error is a measure of the output error between an ideal DAC and the actual device output. It is measured with all 1s in the DAC after offset error has been adjusted out and is expressed in Least Significant Bits. Gain error is adjustable to zero with an external potentiometer.

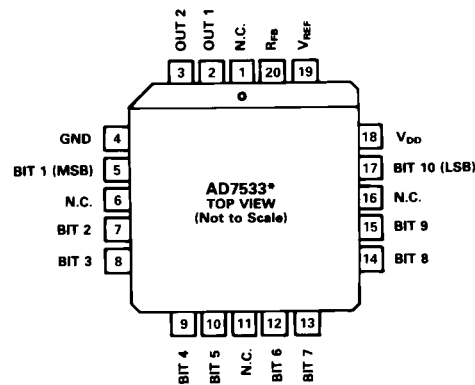
**FEEDTHROUGH ERROR:** Error caused by capacitive coupling from V<sub>REF</sub> to output with all switches OFF.

**OUTPUT CAPACITANCE:** Capacity from I<sub>OUT1</sub> and I<sub>OUT2</sub> terminals to ground.

**OUTPUT LEAKAGE CURRENT:** Current which appears on I<sub>OUT1</sub> terminal with all digital inputs LOW or on I<sub>OUT2</sub> terminal when all inputs are HIGH.

**PIN CONFIGURATIONS****DIP**

\*N.C. ARE NO CONNECT PINS

**LCCC**

\*N.C. ARE NO CONNECT PINS

**PLCC**

# AD7533

## CIRCUIT DESCRIPTION

### GENERAL CIRCUIT INFORMATION

The AD7533, a 10-bit multiplying D/A converter, consists of a highly stable thin film R-2R ladder and ten CMOS current switches on a monolithic chip. Most applications require the addition of only an output operational amplifier and a voltage or current reference.

The simplified D/A circuit is shown in Figure 1. An inverted R-2R ladder structure is used – that is, the binary weighted currents are switched between the  $I_{OUT1}$  and  $I_{OUT2}$  bus lines, thus maintaining a constant current in each ladder leg independent of the switch state.

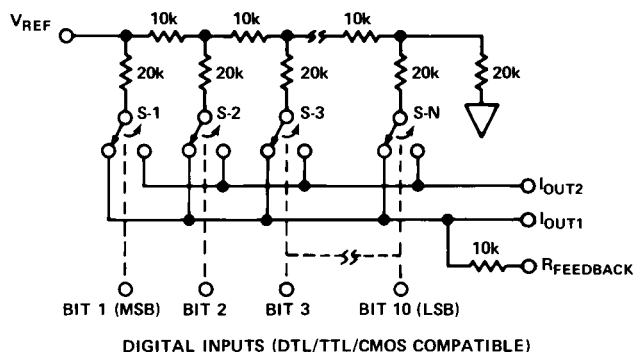


Figure 1. AD7533 Functional Diagram

One of the CMOS current switches is shown in Figure 2. The geometries of devices 1, 2 and 3 are optimized to make the digital control inputs DTL/TTL/CMOS compatible over the full military temperature range. The input stage drives two inverters (devices 4, 5, 6 and 7) which in turn drive the two output N channels. The "ON" resistances of the switches are binary weighted so the voltage drop across each switch is the same. For example, switch 1 of Figure 2 was designed for an "ON" resistance of  $20\Omega$ , switch 2 for  $40\Omega$ , and so on. For a 10V reference input, the current through switch 1 is 0.5mA, the current through switch 2 is 0.25mA, and so on, thus maintaining a constant 10mV drop across each switch. It is essential that each switch voltage drop be equal if the binary weighted current division property of the ladder is to be maintained.

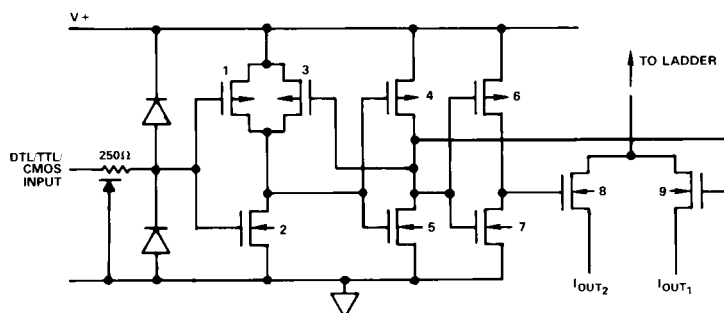


Figure 2. CMOS Switch

### EQUIVALENT CIRCUIT ANALYSIS

The equivalent circuits for all digital inputs high and all digital inputs low are shown in Figures 3 and 4. In Figure 3 with all digital inputs low, the reference current is switched to  $I_{OUT2}$ . The current source  $I_{LEAKAGE}$  is composed of surface and junction leakages to the substrate while the  $\frac{I}{1024}$  current source represents a constant 1-bit current drain through the termination resistor on the R-2R ladder. The "ON" capacitance of the output N channel switch is 100pF, as shown on the  $I_{OUT2}$  terminal. The "OFF" switch capacitance is 35pF, as shown on the  $I_{OUT1}$  terminal. Analysis of the circuit for all digital inputs high, as shown in Figure 4, is similar to Figure 3; however, the "ON" switches are now on terminal  $I_{OUT1}$ , hence the 100pF at that terminal.

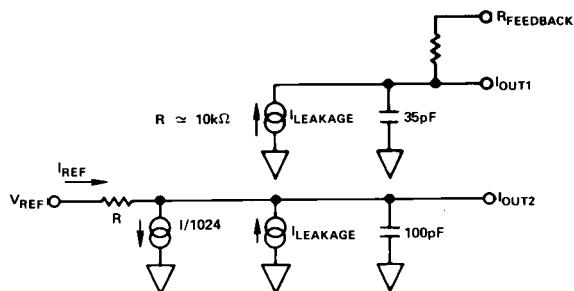


Figure 3. AD7533 Equivalent Circuit – All Digital Inputs Low

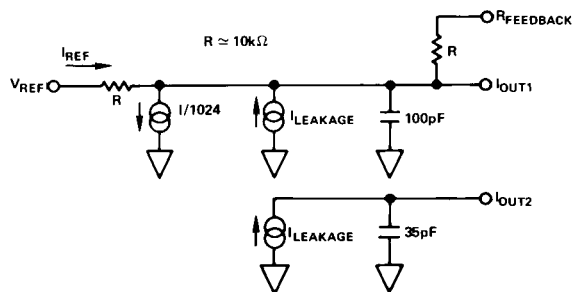


Figure 4. AD7533 Equivalent Circuit – All Digital Inputs High



